A.L.M.T. Corp. Exhibits at the IMS 2018

A.L.M.T. Corp. will participate in IMS2018, scheduled from 12-14, June, 2018. This exhibition is International Microwave symposium. There we will exhibit mainly heatspreaders, including Ag-Diamond, CPC.

IMS 2018

- Dates : 12-14, June, 2018
- Venue : Pennsylvania Convention Center Philadelphia, Pensylvania
- Stand : Booth, 2153, A.L.M.T.Corp. Floor Maps: https://www.expocadweb.com/18ims/ec/forms/attendee/indexTab.aspx

Main Exhibits; Heatspreaders

Ag-Diamond

Characteristics: High Thermal Conductivity, more than 600 W/mK. Low Co-Efficient Thermal Expansion, less than Pure Copper. High Thermal Resistance, it can be worked normal silverbrazing at 800°C.

Applications: High Performance Ceramics Package, Heatspreader for SiC/GaN High Powered Device

CPC

Characteristics: CPC is a composite material with a laminated structure with Cu layers above and below the Cu-Mo composite material. Thermal conductivity and linear expansion coefficient can be changed by combining the composition of the core material Cu-Mo and the lamination ratio. In addition, because both surfaces are Cu, the initial heat radiation effect is excellent.

Applications: Amplifier substrates of mobile phone base stations.

For further detailed information about the exhibition, please refer to https://www.ims2018.org/



The 2018 IEEE MTT-S INTERNATIONAL MICROwave Symposium 10-15 June 2018 Philadelphia, PA